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### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Obsolete
Core Processor	XCore
Core Size	32-Bit 10-Core
Speed	2000MIPS
Connectivity	USB
Peripherals	-
Number of I/O	104
Program Memory Size	2MB (2M x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	512K x 8
Voltage - Supply (Vcc/Vdd)	0.95V ~ 3.6V
Data Converters	-
Oscillator Type	External
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	236-LFBGA
Supplier Device Package	236-FBGA (10x10)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/xmos/xuf210-512-fb236-c20">https://www.e-xfl.com/product-detail/xmos/xuf210-512-fb236-c20</a>

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It is our intention to provide you with accurate and comprehensive documentation for the hardware and software components used in this product. To subscribe to receive updates, visit <http://www.xmos.com/>.

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## 2 XUF210-512-FB236 Features

### ► Multicore Microcontroller with Advanced Multi-Core RISC Architecture

- 10 real-time logical cores on 2 xCORE tiles
- Cores share up to 1000 MIPS
  - Up to 2000 MIPS in dual issue mode
- Each logical core has:
  - Guaranteed throughput of between  $\frac{1}{5}$  and  $\frac{1}{5}$  of tile MIPS
  - 16x32bit dedicated registers
- 167 high-density 16/32-bit instructions
  - All have single clock-cycle execution (except for divide)
  - 32x32→64-bit MAC instructions for DSP, arithmetic and user-definable cryptographic functions

### ► USB PHY, fully compliant with USB 2.0 specification

### ► Programmable I/O

- 128 general-purpose I/O pins, configurable as input or output
  - Up to 32 x 1bit port, 12 x 4bit port, 8 x 8bit port, 4 x 16bit port, 2 x 32bit port
  - 8 xCONNECT links
- Port sampling rates of up to 60 MHz with respect to an external clock
- 64 channel ends (32 per tile) for communication with other cores, on or off-chip

### ► Memory

- 512KB internal single-cycle SRAM (max 256KB per tile) for code and data storage
- 16KB internal OTP (max 8KB per tile) for application boot code
- 2MB internal flash for application code and overlays

### ► Hardware resources

- 12 clock blocks (6 per tile)
- 20 timers (10 per tile)
- 8 locks (4 per tile)

### ► JTAG Module for On-Chip Debug

### ► Security Features

- Programming lock disables debug and prevents read-back of memory contents
- AES bootloader ensures secrecy of IP held on external flash memory

### ► Ambient Temperature Range

- Commercial qualification: 0°C to 70°C
- Industrial qualification: -40°C to 85°C

### ► Speed Grade

- 20: 1000 MIPS

### ► Power Consumption

- 570 mA (typical)

### ► 236-pin FBGA package 0.5 mm pitch

## 4 Signal Description

This section lists the signals and I/O pins available on the XUF210-512-FB236. The device provides a combination of 1bit, 4bit, 8bit and 16bit ports, as well as wider ports that are fully or partially (gray) bonded out. All pins of a port provide either output or input, but signals in different directions cannot be mapped onto the same port.

Pins may have one or more of the following properties:

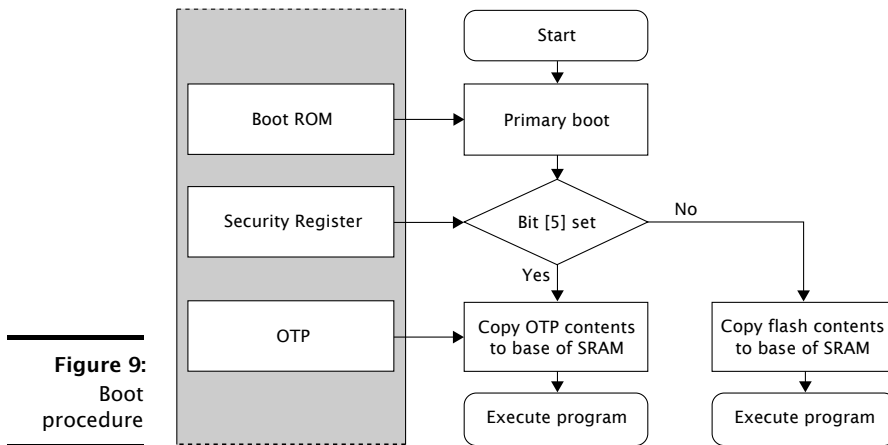
- PD/PU: The IO pin has a weak pull-down or pull-up resistor. The resistor is enabled during and after reset. Enabling a link or port that uses the pin disables the resistor. Thereafter, the resistor can be enabled or disabled under software control. The resistor is designed to ensure defined logic input state for unconnected pins. It should not be used to pull external circuitry. Note that the resistors are highly non-linear and only a maximum pull current is specified in Section 13.2.
- ST: The IO pin has a Schmitt Trigger on its input.
- IOL/IOT/IOR: The IO pin is powered from VDDIOL, VDDIOT, and VDDIOR respectively

Power pins (11)			
Signal	Function	Type	Properties
GND	Digital ground	GND	
OTP_VCC	OTP power supply	PWR	
PLL_AGND	Analog ground for PLL	PWR	
PLL_AVDD	Analog PLL power	PWR	
USB_VDD	Digital tile power	PWR	
USB_VDD33	USB Analog power	PWR	
USB_VSSAC	USB analog ground	GND	
VDD	Digital tile power	PWR	
VDDIOL	Digital I/O power (left)	PWR	
VDDIOR	Digital I/O power (right)	PWR	
VDDIOT	Digital I/O power (top)	PWR	

JTAG pins (6)			
Signal	Function	Type	Properties
RST_N	Global reset input	Input	IOL, PU, ST
TCK	Test clock	Input	IOL, PD, ST
TDI	Test data input	Input	IOL, PU
TDO	Test data output	Output	IOL, PD
TMS	Test mode select	Input	IOL, PU
TRST_N	Test reset input	Input	IOL, PU, ST

Signal	Function	Type	Properties
X0D41	$X_0L0_{in}^0$ 8D <sup>5</sup> 16B <sup>13</sup>	I/O	IOL, PD
X0D42	$X_0L0_{out}^0$ 8D <sup>6</sup> 16B <sup>14</sup>	I/O	IOL, PD
X0D43	$X_0L0_{out}^1$ 8D <sup>7</sup> 16B <sup>15</sup>	I/O	IOL, PD
X0D49	$X_0L5_{in}^4$ 32A <sup>0</sup>	I/O	IOR, PD
X0D50	$X_0L5_{in}^3$ 32A <sup>1</sup>	I/O	IOR, PD
X0D51	$X_0L5_{in}^2$ 32A <sup>2</sup>	I/O	IOR, PD
X0D52	$X_0L5_{in}^1$ 32A <sup>3</sup>	I/O	IOR, PD
X0D53	$X_0L5_{in}^0$ 32A <sup>4</sup>	I/O	IOR, PD
X0D54	$X_0L5_{out}^0$ 32A <sup>5</sup>	I/O	IOR, PD
X0D55	$X_0L5_{out}^1$ 32A <sup>6</sup>	I/O	IOR, PD
X0D56	$X_0L5_{out}^2$ 32A <sup>7</sup>	I/O	IOR, PD
X0D57	$X_0L5_{out}^3$ 32A <sup>8</sup>	I/O	IOR, PD
X0D58	$X_0L5_{out}^4$ 32A <sup>9</sup>	I/O	IOR, PD
X0D61	$X_0L6_{in}^4$ 32A <sup>10</sup>	I/O	IOR, PD
X0D62	$X_0L6_{in}^3$ 32A <sup>11</sup>	I/O	IOR, PD
X0D63	$X_0L6_{in}^2$ 32A <sup>12</sup>	I/O	IOR, PD
X0D64	$X_0L6_{in}^1$ 32A <sup>13</sup>	I/O	IOR, PD
X0D65	$X_0L6_{in}^0$ 32A <sup>14</sup>	I/O	IOR, PD
X0D66	$X_0L6_{out}^0$ 32A <sup>15</sup>	I/O	IOR, PD
X0D67	$X_0L6_{out}^1$ 32A <sup>16</sup>	I/O	IOR, PD
X0D68	$X_0L6_{out}^2$ 32A <sup>17</sup>	I/O	IOR, PD
X0D69	$X_0L6_{out}^3$ 32A <sup>18</sup>	I/O	IOR, PD
X0D70	$X_0L6_{out}^4$ 32A <sup>19</sup>	I/O	IOR, PD
X1D00	$X_0L7_{in}^2$ 1A <sup>0</sup>	I/O	IOR, PD
X1D01	$X_0L7_{in}^1$ 1B <sup>0</sup>	I/O	IOR, PD
X1D02	$X_0L4_{in}^0$ 4A <sup>0</sup> 8A <sup>0</sup> 16A <sup>0</sup> 32A <sup>20</sup>	I/O	IOR, PD
X1D03	$X_0L4_{out}^0$ 4A <sup>1</sup> 8A <sup>1</sup> 16A <sup>1</sup> 32A <sup>21</sup>	I/O	IOR, PD
X1D04	$X_0L4_{out}^1$ 4B <sup>0</sup> 8A <sup>2</sup> 16A <sup>2</sup> 32A <sup>22</sup>	I/O	IOR, PD
X1D05	$X_0L4_{out}^2$ 4B <sup>1</sup> 8A <sup>3</sup> 16A <sup>3</sup> 32A <sup>23</sup>	I/O	IOR, PD
X1D06	$X_0L4_{out}^3$ 4B <sup>2</sup> 8A <sup>4</sup> 16A <sup>4</sup> 32A <sup>24</sup>	I/O	IOR, PD
X1D07	$X_0L4_{out}^4$ 4B <sup>3</sup> 8A <sup>5</sup> 16A <sup>5</sup> 32A <sup>25</sup>	I/O	IOR, PD
X1D08	$X_0L7_{in}^4$ 4A <sup>2</sup> 8A <sup>6</sup> 16A <sup>6</sup> 32A <sup>26</sup>	I/O	IOR, PD
X1D09	$X_0L7_{in}^3$ 4A <sup>3</sup> 8A <sup>7</sup> 16A <sup>7</sup> 32A <sup>27</sup>	I/O	IOR, PD
X1D10	1C <sup>0</sup>	I/O	IOT, PD
X1D11	1D <sup>0</sup>	I/O	IOT, PD
X1D12	1E <sup>0</sup>	I/O	IOL, PD
X1D13	1F <sup>0</sup>	I/O	IOL, PD
X1D14	4C <sup>0</sup> 8B <sup>0</sup> 16A <sup>8</sup> 32A <sup>28</sup>	I/O	IOR, PD
X1D15	4C <sup>1</sup> 8B <sup>1</sup> 16A <sup>9</sup> 32A <sup>29</sup>	I/O	IOR, PD
X1D16	$X_0L3_{in}^1$ 4D <sup>0</sup> 8B <sup>2</sup> 16A <sup>10</sup>	I/O	IOL, PD
X1D17	$X_0L3_{in}^0$ 4D <sup>1</sup> 8B <sup>3</sup> 16A <sup>11</sup>	I/O	IOL, PD
X1D18	$X_0L3_{out}^0$ 4D <sup>2</sup> 8B <sup>4</sup> 16A <sup>12</sup>	I/O	IOL, PD
X1D19	$X_0L3_{out}^1$ 4D <sup>3</sup> 8B <sup>5</sup> 16A <sup>13</sup>	I/O	IOL, PD

(continued)



program size and the program itself. The polynomial used is 0xEDB88320 (IEEE 802.3); the CRC register is initialized with 0xFFFFFFFF and the residue is inverted to produce the CRC.

## 8.1 Security register

The security register enables security features on the xCORE tile. The features shown in Figure 10 provide a strong level of protection and are sufficient for providing strong IP security.

# 9 Memory

## 9.1 OTP

Each xCORE Tile integrates 8 KB one-time programmable (OTP) memory along with a security register that configures system wide security features. The OTP holds data in four sectors each containing 512 rows of 32 bits which can be used to implement secure bootloaders and store encryption keys. Data for the security register is loaded from the OTP on power up. All additional data in OTP is copied from the OTP to SRAM and executed first on the processor.

The OTP memory is programmed using three special I/O ports: the OTP address port is a 16-bit port with resource ID 0x100200, the OTP data is written via a 32-bit port with resource ID 0x200100, and the OTP control is on a 16-bit port with ID 0x100300. Programming is performed through `libotp` and `xburn`.

## 9.2 SRAM

Each xCORE Tile integrates a single 256KBSRAM bank for both instructions and data. All internal memory is 32 bits wide, and instructions are either 16-bit or

debug mode. Software can set the behavior of the xCORE Tile based on this pin. This pin should have an external pull up of 4K7-47K $\Omega$  or left not connected in single core applications.

The JTAG device identification register can be read by using the IDCODE instruction. Its contents are specified in Figure 14.

**Figure 14:**  
IDCODE  
return value

Bit3			Device Identification Register																								Bit0					
Version				Part Number																Manufacturer Identity												1
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	0	0	1	1	0	0	0	1	1	0	0	1	1
0				0				0				0				6				6				3				3				

The JTAG usercode register can be read by using the USERCODE instruction. Its contents are specified in Figure 15. The OTP User ID field is read from bits [22:31] of the security register on xCORE Tile 0, *see* §9.1 (all zero on unprogrammed devices).

**Figure 15:**  
USERCODE  
return value

Usercode Register																																Bit0
OTP User ID																Unused				Silicon Revision												
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	1	0	0	0	0	0	0	0	0	0	0
0				0				0				2				8				0				0				0				0

## 12 Board Integration

The device has the following power supply pins:

- ▶ VDD pins for the xCORE Tile, including a USB\_VDD pin that powers the USB PHY
- ▶ VDDIO pins for the I/O lines. Separate I/O supplies are provided for the left, top, and right side of the package; different I/O voltages may be supplied on those. The signal description (Section 4) specifies which I/O is powered from which power-supply
- ▶ PLL\_AVDD pins for the PLL
- ▶ OTP\_VCC pins for the OTP
- ▶ A USB\_VDD33 pin for the analogue supply to the USB-PHY

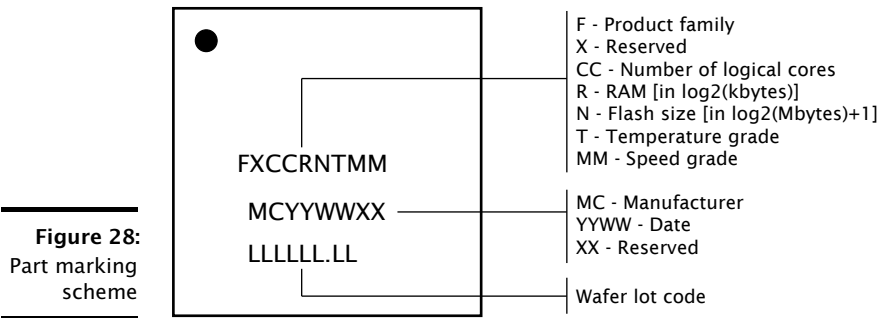
Several pins of each type are provided to minimize the effect of inductance within the package, all of which must be connected. The power supplies must be brought up monotonically and input voltages must not exceed specification at any time.

The VDD supply must ramp from 0V to its final value within 10 ms to ensure correct startup.

The VDDIO and OTP\_VCC supply must ramp to its final value before VDD reaches 0.4V.

The PLL\_AVDD supply should be separated from the other noisier supplies on the board. The PLL requires a very clean power supply, and a low pass filter (for

14.1 Part Marking



15 Ordering Information

**Figure 29:**  
Orderable  
part numbers

Product Code	Marking	Qualification	Speed Grade
XUF210-512-FB236-C20	U11092C20	Commercial	1000 MIPS
XUF210-512-FB236-I20	U11092I20	Industrial	1000 MIPS



A write message comprises the following:

control-token 36	24-bit response channel-end identifier	8-bit register number	8-bit size	data	control-token 1
---------------------	---	--------------------------	---------------	------	--------------------

The response to a write message comprises either control tokens 3 and 1 (for success), or control tokens 4 and 1 (for failure).

A read message comprises the following:

control-token 37	24-bit response channel-end identifier	8-bit register number	8-bit size	control-token 1
---------------------	---	--------------------------	---------------	--------------------

The response to the read message comprises either control token 3, data, and control-token 1 (for success), or control tokens 4 and 1 (for failure).

## B Processor Status Configuration

The processor status control registers can be accessed directly by the processor using processor status reads and writes (use `getps(reg)` and `setps(reg,value)` for reads and writes).

Number	Perm	Description
0x00	RW	RAM base address
0x01	RW	Vector base address
0x02	RW	xCORE Tile control
0x03	RO	xCORE Tile boot status
0x05	RW	Security configuration
0x06	RW	Ring Oscillator Control
0x07	RO	Ring Oscillator Value
0x08	RO	Ring Oscillator Value
0x09	RO	Ring Oscillator Value
0x0A	RO	Ring Oscillator Value
0x0C	RO	RAM size
0x10	DRW	Debug SSR
0x11	DRW	Debug SPC
0x12	DRW	Debug SSP
0x13	DRW	DGETREG operand 1
0x14	DRW	DGETREG operand 2
0x15	DRW	Debug interrupt type
0x16	DRW	Debug interrupt data
0x18	DRW	Debug core control
0x20 .. 0x27	DRW	Debug scratch
0x30 .. 0x33	DRW	Instruction breakpoint address
0x40 .. 0x43	DRW	Instruction breakpoint control
0x50 .. 0x53	DRW	Data watchpoint address 1
0x60 .. 0x63	DRW	Data watchpoint address 2
0x70 .. 0x73	DRW	Data breakpoint control register
0x80 .. 0x83	DRW	Resources breakpoint mask
0x90 .. 0x93	DRW	Resources breakpoint value
0x9C .. 0x9F	DRW	Resources breakpoint control register

**Figure 31:**  
Summary

### B.1 RAM base address: 0x00

This register contains the base address of the RAM. It is initialized to 0x00040000.

<b>0x00:</b> RAM base address	Bits	Perm	Init	Description
	31:2	RW		Most significant 16 bits of all addresses.
	1:0	RO	-	Reserved

### B.2 Vector base address: 0x01

Base address of event vectors in each resource. On an interrupt or event, the 16 most significant bits of the destination address are provided by this register; the least significant 16 bits come from the event vector.

<b>0x01:</b> Vector base address	Bits	Perm	Init	Description
	31:18	RW		The event and interrupt vectors.
	17:0	RO	-	Reserved

### B.3 xCORE Tile control: 0x02

Register to control features in the xCORE tile

**0x12:**  
Debug SSP

Bits	Perm	Init	Description
31:0	DRW		Value.

### B.15 DGETREG operand 1: 0x13

The resource ID of the logical core whose state is to be read.

**0x13:**  
DGETREG  
operand 1

Bits	Perm	Init	Description
31:8	RO	-	Reserved
7:0	DRW		Thread number to be read

### B.16 DGETREG operand 2: 0x14

Register number to be read by DGETREG

**0x14:**  
DGETREG  
operand 2

Bits	Perm	Init	Description
31:5	RO	-	Reserved
4:0	DRW		Register number to be read

### B.17 Debug interrupt type: 0x15

Register that specifies what activated the debug interrupt.

**0x15:**  
Debug  
interrupt type

Bits	Perm	Init	Description
31:18	RO	-	Reserved
17:16	DRW		Number of the hardware breakpoint/watchpoint which caused the interrupt (always 0 for =HOST= and =DCALL=). If multiple breakpoints/watchpoints trigger at once, the lowest number is taken.
15:8	DRW		Number of thread which caused the debug interrupt (always 0 in the case of =HOST=).
7:3	RO	-	Reserved
2:0	DRW	0	Indicates the cause of the debug interrupt 1: Host initiated a debug interrupt through JTAG 2: Program executed a DCALL instruction 3: Instruction breakpoint 4: Data watch point 5: Resource watch point

**0x9C .. 0x9F:**  
Resources  
breakpoint  
control  
register

Bits	Perm	Init	Description
31:24	RO	-	Reserved
23:16	DRW	0	A bit for each thread in the machine allowing the breakpoint to be enabled individually for each thread.
15:2	RO	-	Reserved
1	DRW	0	When 0 break when condition A is met. When 1 = break when condition B is met.
0	DRW	0	When 1 the instruction breakpoint is enabled.

<b>0x00:</b> Device identification	Bits	Perm	Init	Description
	31:24	CRO		Processor ID of this XCore.
	23:16	CRO		Number of the node in which this XCore is located.
	15:8	CRO		XCore revision.
	7:0	CRO		XCore version.

## C.2 xCORE Tile description 1: 0x01

This register describes the number of logical cores, synchronisers, locks and channel ends available on this xCORE tile.

<b>0x01:</b> xCORE Tile description 1	Bits	Perm	Init	Description
	31:24	CRO		Number of channel ends.
	23:16	CRO		Number of the locks.
	15:8	CRO		Number of synchronisers.
	7:0	RO	-	Reserved

## C.3 xCORE Tile description 2: 0x02

This register describes the number of timers and clock blocks available on this xCORE tile.

<b>0x02:</b> xCORE Tile description 2	Bits	Perm	Init	Description
	31:16	RO	-	Reserved
	15:8	CRO		Number of clock blocks.
	7:0	CRO		Number of timers.

## C.4 Control PSwitch permissions to debug registers: 0x04

This register can be used to control whether the debug registers (marked with permission CRW) are accessible through the tile configuration registers. When this bit is set, write -access to those registers is disabled, preventing debugging of the xCORE tile over the interconnect.

**0x07:**  
Security  
configuration

Bits	Perm	Init	Description
31	CRO		Disables write permission on this register
30:15	RO	-	Reserved
14	CRO		Disable access to XCore's global debug
13	RO	-	Reserved
12	CRO		lock all OTP sectors
11:8	CRO		lock bit for each OTP sector
7	CRO		Enable OTP redundancy
6	RO	-	Reserved
5	CRO		Override boot mode and read boot image from OTP
4	CRO		Disable JTAG access to the PLL/BOOT configuration registers
3:1	RO	-	Reserved
0	CRO		Disable access to XCore's JTAG debug TAP

## C.8 Debug scratch: 0x20 .. 0x27

A set of registers used by the debug ROM to communicate with an external debugger, for example over the switch. This is the same set of registers as the [Debug Scratch registers in the processor status](#).

**0x20 .. 0x27:**  
Debug  
scratch

Bits	Perm	Init	Description
31:0	CRW		Value.

## C.9 PC of logical core 0: 0x40

Value of the PC of logical core 0.

**0x40:**  
PC of logical  
core 0

Bits	Perm	Init	Description
31:0	CRO		Value.

## C.10 PC of logical core 1: 0x41

Value of the PC of logical core 1.

## E USB Node Configuration

The USB node control registers can be accessed using configuration reads and writes (use `write_node_config_reg(device, ...)` and `read_node_config_reg(device, ...)` for reads and writes).

**Figure 34:**  
Summary

Number	Perm	Description
0x00	RO	<a href="#">Device identification register</a>
0x04	RW	<a href="#">Node configuration register</a>
0x05	RW	<a href="#">Node identifier</a>
0x51	RW	<a href="#">System clock frequency</a>
0x80	RW	<a href="#">Link Control and Status</a>

### E.1 Device identification register: 0x00

This register contains version information, and information on power-on behavior.

**0x00:**  
Device  
identification  
register

Bits	Perm	Init	Description
31:24	RO	0x0F	Chip identifier
23:16	RO	-	Reserved
15:8	RO	0x02	Revision number of the USB block
7:0	RO	0x00	Version number of the USB block

### E.2 Node configuration register: 0x04

This register is used to set the communication model to use (1 or 3 byte headers), and to prevent any further updates.

**0x04:**  
Node  
configuration  
register

Bits	Perm	Init	Description
31	RW	0	Set to 1 to disable further updates to the node configuration and link control and status registers.
30:1	RO	-	Reserved
0	RW	0	Header mode. 0: 3-byte headers; 1: 1-byte headers.



## F USB PHY Configuration

The USB PHY is connected to the ports shown in section 10.

The *USB PHY* is peripheral 1. The control registers are accessed using 32-bit reads and writes (use `write_periph_32(device, 1, ...)` and `read_periph_32(device, ↪ 1, ...)` for reads and writes).

Number	Perm	Description
0x00	WO	UIFM reset
0x04	RW	UIFM IFM control
0x08	RW	UIFM Device Address
0x0C	RW	UIFM functional control
0x10	RW	UIFM on-the-go control
0x14	RO	UIFM on-the-go flags
0x18	RW	UIFM Serial Control
0x1C	RW	UIFM signal flags
0x20	RW	UIFM Sticky flags
0x24	RW	UIFM port masks
0x28	RW	UIFM SOF value
0x2C	RO	UIFM PID
0x30	RO	UIFM Endpoint
0x34	RW	UIFM Endpoint match
0x38	RW	OTG Flags mask
0x3C	RW	UIFM power signalling
0x40	RW	UIFM PHY control

**Figure 35:**  
Summary

### F.1 UIFM reset: 0x00

A write to this register with any data resets all UIFM state, but does not otherwise affect the phy.

**0x00:**  
UIFM reset

Bits	Perm	Init	Description
31:0	WO		Value.

### F.2 UIFM IFM control: 0x04

General settings of the UIFM IFM state machine.

**0x04:**  
UIFM IFM  
control

Bits	Perm	Init	Description
31:8	RO	-	Reserved
7	RW	0	Set to 1 to enable XEVACKMODE mode.
6	RW	0	Set to 1 to enable SOFISTOKEN mode.
5	RW	0	Set to 1 to enable UIFM power signalling mode.
4	RW	0	Set to 1 to enable IF timing mode.
3	RO	-	Reserved
2	RW	0	Set to 1 to enable UIFM linestate decoder.
1	RW	0	Set to 1 to enable UIFM CHECKTOKENS mode.
0	RW	0	Set to 1 to enable UIFM DOTOKENS mode.

### F.3 UIFM Device Address: 0x08

The device address whose packets should be received. 0 until enumeration, it should be set to the assigned value after enumeration.

**0x08:**  
UIFM Device  
Address

Bits	Perm	Init	Description
31:7	RO	-	Reserved
6:0	RW	0	The enumerated USB device address must be stored here. Only packets to this address are passed on.

### F.4 UIFM functional control: 0x0C

**0x0C:**  
UIFM  
functional  
control

Bits	Perm	Init	Description
31:5	RO	-	Reserved
4:2	RW	1	Set to 0 to disable UIFM to UTMI+ OPMODE mode.
1	RW	1	Set to 1 to switch UIFM to UTMI+ TERMSELECT mode.
0	RW	1	Set to 1 to switch UIFM to UTMI+ XCVRSELECT mode.

### F.5 UIFM on-the-go control: 0x10

This register is used to negotiate an on-the-go connection.

0x10: UIFM on-the-go control	Bits	Perm	Init	Description
	31:8	RO	-	Reserved
	7	RW	0	Set to 1 to switch UIFM to EXTVBUSIND mode.
	6	RW	0	Set to 1 to switch UIFM to DRVVBUSEXT mode.
	5	RO	-	Reserved
	4	RW	0	Set to 1 to switch UIFM to UTMI+ CHRGVBUS mode.
	3	RW	0	Set to 1 to switch UIFM to UTMI+ DISCHRGVBUS mode.
	2	RW	0	Set to 1 to switch UIFM to UTMI+ DMPULLDOWN mode.
	1	RW	0	Set to 1 to switch UIFM to UTMI+ DPPULLDOWN mode.
	0	RW	0	Set to 1 to switch UIFM to IDPULLUP mode.

## F.6 UIFM on-the-go flags: 0x14

Status flags used for on-the-go negotiation

0x14: UIFM on-the-go flags	Bits	Perm	Init	Description
	31:6	RO	-	Reserved
	5	RO	0	Value of UTMI+ Bvalid flag.
	4	RO	0	Value of UTMI+ IDGND flag.
	3	RO	0	Value of UTMI+ HOSTDIS flag.
	2	RO	0	Value of UTMI+ VBUSVLD flag.
	1	RO	0	Value of UTMI+ SESSVLD flag.
	0	RO	0	Value of UTMI+ SESEND flag.

<b>0x20:</b> UIFM Sticky flags	Bits	Perm	Init	Description
	31:7	RO	-	Reserved
	6:0	RW	0	Stickyness for each flag.

### F.10 UIFM port masks: 0x24

Set of masks that identify how port 1N, port 1O and port 1P are affected by changes to the flags in FLAGS

<b>0x24:</b> UIFM port masks	Bits	Perm	Init	Description
	31:24	RW	0	Bit mask that determines which flags in UIFM_IFM_FLAG[6:0] contribute to port 1?. If any flag listed in this bitmask is high, port 1? will be high.
	23:16	RW	0	Bit mask that determines which flags in UIFM_IFM_FLAG[6:0] contribute to port 1P. If any flag listed in this bitmask is high, port 1P will be high.
	15:8	RW	0	Bit mask that determines which flags in UIFM_IFM_FLAG[6:0] contribute to port 1O. If any flag listed in this bitmask is high, port 1O will be high.
	7:0	RW	0	Bit mask that determines which flags in UIFM_IFM_FLAG[6:0] contribute to port 1N. If any flag listed in this bitmask is high, port 1N will be high.

### F.11 UIFM SOF value: 0x28

USB Start-Of-Frame counter

<b>0x28:</b> UIFM SOF value	Bits	Perm	Init	Description
	31:11	RO	-	Reserved
	10:8	RW	0	Most significant 3 bits of SOF counter
	7:0	RW	0	Least significant 8 bits of SOF counter

### F.12 UIFM PID: 0x2C

The last USB packet identifier received

## J Associated Design Documentation

Document Title	Information	Document Number
Estimating Power Consumption For XS1-UF Devices	Power consumption	
Programming XC on XMOS Devices	Timers, ports, clocks, cores and channels	<a href="#">X9577</a>
xTIMEcomposer User Guide	Compilers, assembler and linker/mapper Timing analyzer, xScope, debugger Flash and OTP programming utilities	<a href="#">X3766</a>

## K Related Documentation

Document Title	Information	Document Number
The XMOS XS1 Architecture	ISA manual	<a href="#">X7879</a>
XS1 Port I/O Timing	Port timings	<a href="#">X5821</a>
xCONNECT Architecture	Link, switch and system information	<a href="#">X4249</a>
XS1-UF Link Performance and Design Guidelines	Link timings	
XS1-UF Clock Frequency Control	Advanced clock control	